### SPECIFICATION

TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN THAT WE, Hiroji Ebe, a citizen of Japan residing at Kawasaki, Japan, Yoshiaki Nakata, a citizen of Japan residing at Kawasaki, Japan, Mitsuru Sugawara, a citizen of Japan residing at Kawasaki, Japan, Takashi Kita, a citizen of Japan residing at Kadoma, Japan, Osamu Wada, a citizen of Japan residing at Kobe, Japan and Yasuhiko Arakawa, a citizen of Japan residing at Kawasaki, Japan have invented certain new and useful improvements in

QUANTUM OPTICAL SEMICONDUCTOR DEVICE

of which the following is a specification:-

# TITLE OF THE INVENTION

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OUANTUM OPTICAL SEMICONDUCTOR DEVICE

# CROSS-REFERENCE TO RELATED APPLICATION

The present application is based on Japanese priority application No.2002-273178 filed on September 19, 2002, the entire contents of which are hereby incorporated by reference.

# 10 BACKGROUND OF THE INVENTION

The present invention generally relates to semiconductor devices and more particularly to a quantum optical semiconductor device having a quantum dot structure therein.

In a bulk semiconductor crystal where there is no carrier confinement, the state density of the carriers increases continuously with energy in the form of parabolic curve. In a quantum well structure in which there exists one-dimensional carrier confinement, on the other hand, there appear quantum levels as a result of such a one-dimensional carrier confinement, and the state density is changed to have a stepwise form that changes stepwise with energy in correspondence to the quantum levels that characterize the quantum well structure.

Because of the stepwise state density, the carriers experience restriction with regard to the energy distribution in such a system, and thus, the use of quantum well structure in an optical semiconductor device such as a laser diode leads to an advantageous feature of sharp and narrowly confined optical spectrum, which is superior to the spectrum of a laser diode that uses a bulk semiconductor crystal. In the case of light-emitting devices including laser diodes, the use of a quantum well structure further provides improvement in the efficiency of optical emission. Further, a quantum well structure can be

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used also as an energy filter in electron devices
                                                                               having a resonant tunneling barrier such as RHET
                                                                              (resonant hot-electron transistor).
                                                                        the degree of carrier confinement is increased further,

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                                                                      the state density is changed further, because of the
                                                                    existence of the two-dimensional carrier confinement, in
                                                                 Such that there appears a maximum of state density in
                                                               each of the steps at the bottom edge thereof. As a
                                                             result, the steps at the bottom eage thereor. As a string of the
                                                           carriers is increased further.
                                                      which in the degree of carrier confinement is increased
                                                    further there appears a discrete state density
                                                 distribution as a result of the three-dimensional
                                               Carrier Confinement, and associated with thus, the
                                             energy spectrum of the carriers becomes totally
                                           discrete in correspondence to the discrete quantum
                                          levels.
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                                    spectrum, transition of carriers occurs
                                                             In the system having such a discrete energy
                                  discontinuously from a quantum level to another
                               quantum level, even in case the system is held in a
                             quantum tevet, even in case

toom temperature environment where there are caused

while the caused the system is metal in a
                          plenty of thermal excitations. Thus, by using such a
                         quantum dot structure, it becomes possible to realize
                      an optical structure, it becomes possible to realing the device having a very sharp
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             energy spectrum in an electron device having a
           resonant tunneling barrier not only at low
         temperatures but also at the room temperature in the read to the anergy
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quantum-dot substrate by utilizing the of the substrate by to the case of the semiconductor substrate similarly to the case of the semiconductor similarly to the case of the substrate. quantum-dot structure also on an inclined electron-beam lithography. on the substrate, similarly to the case of the approach on the substrate, structure. However, and process ancounters quantum well wire the conventional process ancounters. semiconductor substrate by utilizing the surface of the similarly to the case each an a semiconductor substrate, structure however and the substrate of the subst quantum-well wire structure. However, such an approach of extrapolating the conventional process encounters the conventional process encounters the difficulty of controlling the various problems such as difficulty of converge of various problems such as enrich a substrate enrich enr Various proplems such as ullillourly of occurrence of steps on such a substrate surface, mantum-dot interface steps of of olemants at the mantum-dot interface. steps on such a substrate surface, occurrence or and the quantum dot interface, alements at the quantum of alements at the quantum of alements at the raised a miving of alements at the raised and a miving of a m mixing of elements at the quantum of linterrace, and mixing of elements, the like. When characters of compactific to the like. the desired sharp quantum dot surface. It thours now the attained at the process of a stained at the process of a the desired sharp change of composition is not the of a patterning process such as lithography tor causes substantial inevitably causes substantial forming the quantum dot accarned as the quantum out surface. Further for of a patterning process such as lithography of a patterning process. 20 Meanwhile, data on a state of a grant of the state of a Meanwhile, there has been proposed a process

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For example, there is a report (Leonard, D. et al., Appl. Phys. Lett. 63, pp.3203 - 3205, 1993) of successful formation of islands of InGaAs on a GaAs substrate with a diameter of 30 - 40nm, by growing an InGaAs layer having an In content of about 0.5 on a GaAs substrate, which has a lattice constant substantially different from the lattice constant of the InGaAs layer.

Further, there is a report (Mukai, K., et al., Jpn. J. Appl. Phys. 33, pp.L1710 - L1712, 1994) of forming islands of InGaAs on a GaAs substrate with a diameter of 15 - 20nm by using an ALE process such that the InGaAs islands are separated from each other with an interval of about 100nm.

Further, it is reported that similar quantum dots can be formed also by an MOVPE process (Oshinowo, J., et al., Appl. Phys. Lett. 65, (11), pp.1421-1423 (1994).

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Because such formation of quantum dots in a strained heteroepitaxial system is controlled by the strain energy formed at the heterointerface, the formation of the quantum dots is much more simpler than the conventional process of forming the quantum dots. Further, because the process does not use any patterning process such as an electron-beam lithography, there occurs no such a problem that the obtained quantum dots are damaged during the formation process.

Because the foregoing S-K mode growth relies upon the use of lattice-mismatched material system, a quantum dot formed by the S-K mode growth generally accumulates therein a non-uniform strain characterized by an in-plane compressive strain. Further, the quantum dot accumulates a tensile strain or weak compressive strain in the growth direction.

FIG.1 shows the construction of a quantum semiconductor device disclosed in the Japanese Laid-

Open Patent Publication 9-326506 that uses quantum dots formed by the S-K mode growth process.

Referring to FIG.1, a number of InAs quantum dots 3b are formed on a GaAs substrate 1 having a (100)-oriented surface via a GaAs buffer layer 2 by the S-K mode growth process, wherein the InAs quantum dots 3b are formed in plural layers on the GaAs substrate 1 and are embedded in a GaAs intermediate layer or barrier layer 3a in each of the layers. Further, the quantum dots 3b of the next layer are grown on the barrier layer 3a burying the quantum dots 3b underneath.

In the example of FIG.1, each of the quantum dots 3b induces a severe strain in the barrier layer 3a covering the quantum dot 3b particularly at the part contacting the apex part of the quantum dot 3b, and as a result, each quantum dot 3b of the next layer tends to grow on the barrier layer 3a in the part immediately above an underlying quantum dot 3b. Thus, there is achieved an alignment of the quantum dots 3b in the direction perpendicular to the surface of the substrate 1 in the case the growth of the barrier layer 3a and the quantum dots 3b is conducted repeatedly.

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Thus, by using the quantum semiconductor structure of FIG.1, it is possible to construct a quantum optical semiconductor device such as a laser diode, optical amplifier, optical switch, wavelength conversion element, and the like, that constitutes an all-optical network or so-called photonic network.

In the case of using such a quantum optical semiconductor device in a photonic network, it should be noted that the quantum optical semiconductor device is required to have a polarization-free

optical fibers.

In the case of the quantum dots that uses the S-K mode growth as explained with reference to FIG.1, on the other hand, the quantum dots have generally a flat shape and accumulate non-isotropic strain therein as noted before, and because of this, construction of optical semiconductor devices has been successful only in the case the optical semiconductor device is the one that amplifies or emits the optical beam of TE mode, as long as the quantum dots formed by the S-K process are used for the active part of the optical semiconductor device. Thus, it has been difficult to construct a polarization-free device, which is required in the actual optical network systems.

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In more detail, a non-isotropic strain applied to a quantum dot induces separation of a heavy hole level from a light hole level in the hole level constituting the valence band, and because of this, there appears an energy difference  $\Delta E_{1-h}$  between the light hole level and the heavy hole level as

$$\Delta E_{1-h} = -2b \left( \epsilon_{zz} - \epsilon_{xx} \right),$$
 (1)

wherein b is a negative constant called uniaxial deformation potential while  $\epsilon_{xx}$  and  $\epsilon_{zz}$  represent respectively the in-plane strain component acting in the direction parallel to the substrate and a strain component acting perpendicular to the substrate surface. In Eq.(1), the positive value of the strain  $\epsilon_{zz}$  or  $\epsilon_{xx}$  represents a tensile strain while the negative value represents a compressive strain.

Thus, in the case of the conventional quantum dots that accumulates a compressive strain in the in-plane direction, the energy difference  $\Delta E_{1-h}$  takes a positive value and thus, the energy difference between the electron level and the heavy hole level becomes smaller than the energy difference between the

electron level and the light hole level. As a result, there occurs optical transition between the heavy hole level and the electron level forming the conduction band as represented in FIG.2.

Meanwhile, it should be noted that such optical transition occurs in the quantum dot only in the case the electric field component of the incoming optical radiation has a direction perpendicular to the wave vector k of the electron waves in the quantum dot. In a flat quantum dot formed by the S-K growth process, it should be noted that quantization of electrons is caused mainly for the electron wave component perpendicular to the substrate surface, and thus, the wave vector k of the electron wave becomes perpendicular to the substrate surface.

Thus, in the quantum dot formed by the S-K mode growth, the interaction between the incoming optical radiation and the electron wave occurs only in the case the incoming optical radiation is a TE-mode optical beam characterized by the electric field parallel to the substrate surface.

Thus, quantum optical semiconductor devices that use quantum dots formed by the S-K mode growth process generally show remarkable polarization dependence, and because of this, it has been difficult to construct a photonic network, which requires polarization—free optical characteristics for the components constituting the network, by using such conventional quantum optical semiconductor devices unless additional optical system is provided for compensating for the polarization—dependence of the quantum dots. However, such an additional optical system is complex and increases the cost of the optical network.

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# SUMMARY OF THE INVENTION

Accordingly, it is a general object of the

present invention to provide a novel and useful quantum semiconductor device wherein the foregoing problems are eliminated.

Another and more specific object of the present invention is to provide a quantum semiconductor device having a quantum dot formed by an S-K mode growth process wherein the polarization dependence is eliminated.

Another object of the present invention is to provide a quantum semiconductor device having a quantum dot formed by an S-K mode growth process and yet capable of operating on the optical radiation of TM-mode.

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Another object of the present invention is to provide a quantum optical semiconductor device, comprising:

a semiconductor substrate; and
an active layer formed on said semiconductor
substrate and including therein a quantum structure,
said quantum structure comprising:

a first barrier layer of a first semiconductor crystal having a first lattice constant and a first bandgap;

a second barrier layer of a second semiconductor crystal formed epitaxially on said first barrier layer, said second semiconductor crystal having a second lattice constant and a second bandgap;

a plurality of quantum dots formed in said second barrier layer, each of said quantum dots comprising a semiconductor crystal forming a strained system with regard to said first and second semiconductor crystals and having a lattice constant different from said first lattice constant and a bandgap smaller than any of said first and second bandgaps, each of said quantum dots having a height substantially identical with a thickness of said second barrier layer; and

a third barrier layer of a third semiconductor crystal formed on said second barrier layer, said third semiconductor crystal having a lattice constant different from said lattice constant of said semiconductor crystal constituting said quantum dot, said third semiconductor crystal further having a third bandgap larger than said bandgap of said semiconductor crystal forming said quantum dot,

said third barrier layer making a contact with an apex of said quantum dot formed in said second barrier layer.

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Another object of the present invention is to provide a quantum optical semiconductor device, comprising:

a semiconductor substrate; and
an active layer formed on said semiconductor
substrate and including a quantum structure therein,
said quantum structure comprising:

a first barrier layer of a first semiconductor crystal having a first lattice constant and a first bandgap;

a second barrier layer of a second semiconductor crystal formed epitaxially on said first barrier layer, said second semiconductor crystal having a second lattice constant and a second bandgap;

a plurality of quantum dots formed in said second barrier layer, each of said quantum dots comprising a semiconductor crystal forming a strained system with respect to said first and second semiconductor crystals and having a lattice constant different from said first lattice constant and a bandgap smaller than any of said first and second bandgaps, each of said quantum dots having a height substantially equal to a thickness of said second barrier layer,

said first barrier layer and said second barrier layer being stacked alternately such that said

first barrier layer makes a contact with an apex of said quantum dot in said second barrier layer,

said first barrier layer and said second barrier layer having respective, different compositions.

In the quantum dot structure of the present invention, the interaction of the quantum dot structure to the optical radiation of TM-mode has a proportion equal to or larger than the interaction to the optical radiation of the TE-mode.

Another object of the present invention is to provide a quantum optical semiconductor device, comprising:

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a semiconductor substrate; and
an active layer formed on said semiconductor
substrate and including a quantum structure therein,
said quantum structure comprising:

a barrier layer of a first semiconductor crystal having a first lattice constant and a first bandgap;

a plurality of quantum dots formed in said barrier layer, each of said quantum dots comprising a semiconductor crystal forming a strained system with respect to said first semiconductor crystal and having a lattice constant different from said first lattice constant and a bandgap smaller than said first bandgap,

said barrier layer containing therein said plurality of quantum dots being staked for a predetermined stack number,

wherein said predetermined stack number is set such that a proportion of interaction of said quantum dots to optical radiation of TM-mode is equal to or larger than a proportion of interaction of said quantum dots to optical radiation of TE-mode.

According to the present invention, optimization is achieved with regard to the strain components acting upon the quantum dots in the in-

plane direction and also in the direction perpendicular to the semiconductor substrate, such that there is realized the relationship  $\epsilon_{zz} < \epsilon_{xx}$  in the foregoing Eq.(1). Thereby, the term  $\Delta E_{1-h}$  becomes negative, and thus, the level of the light holes now becomes the fundamental state of the quantum dot for the holes.

In such quantum dots, optical excitation occurs between the light-hole level and the electron level, and the quantum dots having such optimized strain cause interaction predominantly with the optical radiation of the TM-mode.

Thus, by forming a quantum optical semiconductor device such that the quantum optical semiconductor device includes therein the quantum dots interacting predominantly with the TM-mode optical radiation in addition to the quantum dots interacting predominantly with the TE-mode optical radiation, or alternatively, by optimizing the strain in each quantum dot such that there occurs interaction to the TM-mode optical radiation in the same proportion with the interaction to the TE-mode optical radiation, it becomes possible to realize an optical semiconductor device free from polarization dependence and thus suitable for use in optical network, and the like.

Other objects and further features of the

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# BRIEF DESCRIPTION OF THE DRAWINGS

FIG.1 is a diagram showing the construction of a quantum semiconductor device having the quantum dots formed by conventional S-K mode growth process;

present invention will become apparent from the

following detailed description when read in

conjunction with the attached drawings.

FIG.2 is a diagram showing the schematic band structure of the quantum dot formed by a conventional S-K mode growth process;

FIG.3 is a diagram showing the construction of a quantum semiconductor device according to a first embodiment of the present invention;

FIGS.4A and 4B are diagrams showing the PL energy and TE/TM mode ratio in the quantum semiconductor device of FIG.3;

FIG.5 is a diagram showing the construction of a quantum semiconductor device according to a second embodiment of the present invention;

FIG.6 is a diagram showing the PL spectrum of the semiconductor device of FIG.5;

FIG.7 is a diagram showing the structure appearing in the quantum semiconductor device of FIG.5;

FIG.8 is a diagram showing the construction of a semiconductor device according to a third embodiment of the present invention;

FIG.9 is a diagram showing the relationship between a wavelength of the quantum dot and the  $\frac{1}{2}$ 

barrier layer composition in the structure of FIG.8;
FIG.10 is a diagram showing the construction

of an optical semiconductor device according to a fourth embodiment of the present invention;

FIG.11 is a diagram showing the construction
of an optical semiconductor device according to a
fifth embodiment of the present invention; and

FIG.12 is a diagram showing an example of a photonic network according to a sixth embodiment of the present invention.

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# DETAILED DESCRIPTION OF THE INVENTION [FIRST EMBODIMENT]

FIG.3 shows the construction of a quantum optical semiconductor device 10 according to a first embodiment of the present invention.

Referring to FIG.3, a GaAs buffer layer 12 is formed on a GaAs substrate 11 having a (100)-

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surface orientation, and an InAs layer is formed on
                                                                                                                                                                                                          the GaAs buffer layer and an inas layer is formed of fing with a common at a common at a
                                                                                                                                                                                                     substrate temperature of 510°C with a source supply
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                                                                                                                                                                                         a thickness of about 1.8 molecular layers.
                                                                                                                                                                             formed experiences compressive strain due to the fact
                                                                                                                                                                                                                                             It should be noted that the Inas layer thus
                                                                                                                                                                        that the lattice compressive strain que to the race of the constant of the crystal is larger
                                                                                                                                                                   than the lattice constant or than the lattice constant of the GaAs substrate, and
                                                                                                                                                           as a result, there are formed islands substrate, and hinfformatically of the Galas substrate, and a racing quantum
                                                                                                                                                      dots 13 on the GaAs buffer layer 12 as a result of the fall of the
                                                                                                                                                S-K mode growth. Thereby, the InAs quantum dots 13

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                                   desired quantum structure.
                       (photoluminescence) peak respectively show the plot intensity ratio
                TE/TE for the fundamental state of the quantum optical
          semiconductor device 10 of FIG. 3 as a quantum optical range and r
   number of stacks, wherein the TE/TM ratio represents
the ratio of the TE-mode PL intensity to the TM-mode
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PI intensity. It should be noted that FIG. 4B further and the man 
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The present amendament the transfer to the present amendament it can be seen according to the present amendament.
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                                                                                                                                                                                                                                                                                                       25
                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     the substrate surface (E22 Exx 0).
                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     TIG. 5 Shows the construction of a quantum the construction of a quantum
                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       (SECOND EMBODIMENT)
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optical semiconductor device 20 according to a second embodiment of the present invention.

Referring to FIG.5, the quantum optical semiconductor device 20 is constructed on a GaAs substrate of (100)-surface orientation and covered with a buffer layer 22 of GaAs or AlGaAs, wherein the quantum optical semiconductor device 20 further includes a number of InAs quantum dots 23 formed on the buffer layer 22 by an S-K mode growth conducted by using an MOVPE process.

On the surface on which the S-K growth of the InAs quantum dots 23 occurs, it can be seen that there is formed an extremely thin InAs wetting layer 23a. While not illustrated, a similar wetting layer is used also in the embodiment of FIG.3.

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In the present embodiment, the InAs quantum dots 23 can be formed by supplying source gases at the substrate temperature of  $510^{\circ}$ C, for example, with a supply rate set such that there is caused a growth of InAs layer with a thickness of 1.9 molecular layers. After this, an InGaAs barrier layer 24 is formed epitaxially so as to cover the InAs quantum dots 23 with a composition represented as  $In_xGa_{1-x}As$ .

Further, by repeating the growth of the quantum dots 23 and the InGaAs layer 24 alternately, the quantum optical semiconductor device 20 of FIG.5 is obtained.

FIG.6 shows an example of the PL spectrum observed for the quantum optical semiconductor device 20 of FIG.5, wherein it should be noted that Specimen A of FIG.6 represents the case in which a GaAs layer is used for the barrier layer 24 in place of the InGaAs mixed crystal, while Specimen B represents the case in which an InGaAs mixed crystal having a compositional parameter x of 0.13 (x=0.13) is used for the InGaAs barrier layer 24. In FIG.6, "s", "p" and "d" represent respectively the optical radiation from

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the s-shell, p-shell and d-shell, and thus correspond
                                                                                   to the fundamental level, first excitation level and the shown of the fundamental level, first excitation level and
                                                                                 second excitation level of the quantum dot,
                                                                                respectively.
                                                                          PL radiation of TE-mode is predominant over the which nse
                                                                                                   Referring to FIG. 6, it can be seen that the
                                                                        radiation or The Mode is predominant over the Specimen A, which uses
                                                                     GaAs for the barrier layer 24, for any of the
                                                                   tadiation from the s-shell, p-shell and the d-shell, nsas Incaase
                                                                 While in the case of the Specimen B that uses IngaAs

in the case of the Specimen B that uses IngaAs
                                                              mixed crystal for the specimen strat uses in the barrier layer 24, it can be seen or the seen
                                                            that the PL radiation of TM-mode becomes predominant.
                                                       FIG. 6 indicates that there has been caused an increase of lattice and increase
                                                     of in content, and hence has been caused an increase of lattice constant,
                                                   in the barrier layer 24 in a region 24A thereof
                                                Located immediately above the quantum dot 23 as a range
                                              Lesult of accumulation of strain in such a region 24A.
                                            Associated with the increase of the In concentration of the increase has has has
                                         in the region 24A, it is believed that there has been
                                       Caused a corresponding increase of Ga concentration in
                                     the part of the barrier layer 24 contacting laterally
                                  to the quantum dot 23, leading to local decrease of
                                 the lattice constant in such a region.
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                           reflecting the local result or rive of a line testite of the result or rive of the result or rive of the result or rive of the rive of the
                                                     Thus, the result of FIG.6 is interpreted as
                         barrier layer 24 taking place in the vicinity of the showing he
                       Quantum dot 23 as represented in the vicinity of the chamatin diagram changed be
                    quantum qot <3 as represented in right showing the rices.
                  region surrounding a schematic diagram showing the corresponding dot 23 of FIG.5.
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                In FIG.7 those parts corresponding to the parts
              described previously are designated by the same
           reference previously are designated by the same description thereof will be
           omitted.
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    compositional change caused in the region 24A as shown
  in FIG.5 or 7, is induced by a self-organizing process.
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Thus, there is no need of conducting an external process such as patterning for realizing the structure of FIG.7.

While the foregoing example describes the use of InGaAs for the barrier layer 24, other mixed crystals such as InGaAsP, InAlGaAs, InAlGaP, and the like, can also be used for the barrier layer 24.

### [THIRD EMBODIMENT]

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FIG.8 shows the construction of a quantum semiconductor device 30 according to a third embodiment of the present invention.

Referring to FIG.8, there is formed an InGaAsP barrier layer 32 on an InP substrate 31 having a (100) or (311)B surface orientation via an InP buffer layer not illustrated, and quantum dots 33 of undoped InGaAs or InAs are formed on the InGaAsP barrier layer 32 by an S-K growth process that uses an MOVPE process conducted at the substrate temperature of 450 - 550°C. As a result of such an S-K growth process, there is formed an extremely thin wetting layer 33A on the surface of the InGaAsP barrier layer 32.

Further, the quantum dots 33 are buried by another InGaAsP barrier layer 34 having a composition different from the composition of the InGaAsP barrier layer 32, wherein the barrier layer 32 including therein the quantum dots 33 and the barrier layer 34 are deposited alternately and repeatedly for about 10 cycles. Thereby, the InGaAsP barrier layers 32 and 34 are formed by an MOVPE process at the substrate temperature of 550 - 650°C.

In the structure of FIG.8, it should be noted that the barrier layer 32 makes a contact with an apex of the quantum dot 33 located underneath.

FIG.9 shows the result of calculation of the transition energy Eg (see FIG.2) for the quantum dot

33 as measured from the fundamental state thereof, wherein the calculation is conducted on the structure of FIG.8 for the case the quantum dots 33 are formed of InAs and the barrier layer 32 has a latticematching composition of In<sub>0.717</sub>Ga<sub>0.283</sub>As<sub>0.611</sub>P<sub>0.389</sub>, while changing the composition of the barrier layer 34, represented by  $In_xGa_{1-x}As_vP_{1-v}$ , in the range of  $0.15 \le x \le$ 0.92 and  $0.5 \le y \le 1$ . Thereby, it should be noted that the As-composition y is changed with the Incomposition x such that the bandgap of the InGaAsP barrier layer 34 is maintained larger than the bandgap of the InAs quantum dot 33. Further, it should be noted that the calculation of FIG.9 has been conducted by approximating the InAs quantum dot 33 by a rectangular body having a size of 35nm x 35nm x 10nm. In this structure, the strain components  $\epsilon_{xx}$  and  $\epsilon_{yy}$ of the quantum dot 33 have the value of -0.0067 ( $\epsilon_{xx}$ and  $\epsilon_{yy}$  =-0.0067). It should be noted that the negative value for the strain components  $\epsilon_{xx}$  and  $\epsilon_{yy}$ indicates that the quantum dot 33 accumulates therein 20 a compressive in-plane strain.

Referring to FIG.9, it should be noted that the two-dotted line represents the energy Eghh (001) required in a quantum dot formed on a (001) surface by the S-K mode growth process for exciting a heavy hole to the conduction band, while the continuous line represents the energy Egnh (111) required in a quantum dot formed on a (111) surface by the S-K mode growth process for exciting a heavy hole to the conduction band. Further, the one-dotted line represents the energy  $Eg_{1h}(001)$  required in a quantum dot formed on a (001) surface by the S-K mode growth process for exciting a light hole to the conduction band, while the dotted line represents the energy Eglh (111) required in a quantum dot formed on a (111) surface by the S-K mode growth process for exciting a light hole to the conduction band.

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Referring to FIG.9, it can be seen that there is no substantial effect of crystal orientation on the excitation energy Eg in any of the heavy hole and the light hole. On the other hand, FIG.9 clearly shows that the In content x in the InGaAsP barrier layer 34 provides a profound effect on the excitation energy.

Particularly, it should be noted that the energy difference  $\Delta E_{1-h}$  between the heavy hole and the light hole disappears in the case the In content x has the value of about 0.63. In this state, the polarization dependence of the quantum dot 33 disappears. Thus, in this specific composition, the strain component  $\epsilon_{zz}$ , which acts in the direction perpendicular to the substrate surface, has the value equal to the value of the foregoing strain component  $\epsilon_{xx}$  or  $\epsilon_{yy}$ .

By setting the In composition x to be less than 0.63, the sign of the foregoing energy difference  $\Delta E_{1-h}$  is reversed, and the light hole level becomes the fundamental state in the quantum dot 33. Thus, by using such a quantum dot 33, it becomes possible to construct an quantum semiconductor device that interacts with the TM-mode optical radiation.

In the embodiment of FIG.8, too, it should be noted that there is induced a localized change of composition in the part of the barrier layer 32 and 34 contacting with the quantum dot 33, similarly to the case of FIG.7.

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### [FOURTH EMBODIMENT]

FIG.10 shows the construction of a ridge-guided optical semiconductor device 40 according to a fourth embodiment of the present invention.

Referring to FIG.10, the optical semiconductor device 40 is constructed on an n-type InP substrate 41 having a (311)B orientation, and

there is formed an n-type InP cladding layer 43 on the foregoing n-type InP substrate via an intervening InP buffer layer 42 in an epitaxial relationship with the substrate 41. Typically, the InP substrate 41, the InP buffer layer 42 and the InP cladding layer 43 are doped with a carrier density of about  $1 \times 10^{18} \, \mathrm{cm}^{-3}$ .

On the cladding layer 43, there are formed a plurality of active layers 44 repeatedly, wherein each of the active layers 44 is formed of the lamination of the InGaAsP barrier layers 32 and 34 as explained in the embodiment of FIG.8, and the quantum dots 33 are formed in the barrier layer 34. In the present embodiment, the barrier layer 32 may have the composition of  $In0.717Ga_{0.283}As_{0.611}P_{0.389}$ . Further, the barrier layer 34 may have the composition of  $In0.63Ga_{0.37}As_{0.5}P_{0.5}$ .

Further, an upper cladding layer 45 of p-type InP is formed on the active layer 44 thus formed, and an upper electrode 47 is provided on the cladding layer 45 via an intervening p-type InP contact layer 46. Further, a bottom electrode 48 is provided on the bottom surface of the InP substrate 41.

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In the ridge-guide type optical semiconductor device, it should be noted that the upper cladding layer 45 and the contact layer 46 are patterned to form a ridge structure extending in the axial direction of the device 40, and insulation films 49A and 49B of low refractive index such as SiO<sub>2</sub> or polyimide are formed so as to support the ridge structure at both lateral sides thereof.

As a result, the optical radiation formed in the active layer 44 is guided along the ridge structure and induces stimulated emission therein. Thus, by providing mirrors at both end surfaces of the active layer 44, the device 40 functions as a laser diode. Further, it is possible to construct an optical amplifier by not forming such mirrors.

It should be noted that, in such an optical semiconductor device 40, a polarization-free operation is realized by setting the compositions of the barrier layer 32 and the barrier layer 34 as noted before. Further, by setting the In content of the barrier layer 32 to be less than 0.63, it becomes possible to conduct laser oscillation or optical amplification of TM-mode optical beam. Further, it becomes possible to construct various optical active elements used in an optical network.

In the case an n-type GaAs substrate is used for the substrate 41 in place of the n-type InP substrate, it is possible to use a construction in which the InAs quantum dots 13 and the GaAs barrier layers 14 explained with reference to FIG.3 are stacked, for the active layer 44. Alternatively, it is possible to use the structure in which the InAs quantum dots 23 and the InGaAs barrier layers 24 explained with reference to FIG.5 are stacked for the active layer 44.

#### [FIFTH EMBODIMENT]

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FIG.11 shows the construction of an optical semiconductor device 50 according to a fifth embodiment of the present invention, wherein those parts corresponding to the parts described previously are designated by the same reference numerals and the description thereof will be omitted.

Referring to FIG.11, the optical semiconductor device 50 has a stacked structure similar to that of the optical semiconductor device 40 of the previous embodiment, except that there is formed a mesa structure in a part of the upper cladding layer 45 and the active layer 44 such that the mesa structure reaches the lower cladding layer 43, and the mesa structure thus formed is laterally supported by a pair of current blocking structures 53A

and 53B each having a stacked structure in which a p-type InP layer 51 and an n-type InP layer 52 are laminated.

In such a construction, too, it is possible to construct a laser diode or optical amplifier free from polarization dependence. Further, it is possible to construct various optical active devices such as optical switches used in an optical network.

### 10 [SIXTH EMBODIMENT]

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FIG.12 shows an example of a photonic network 60 constructed by using the optical active device of FIG.10 or FIG.11.

Referring to FIG.12, the photonic network 60 is constructed by connecting a number of nodes 62, including nodes 62A and 62B, with each other by using optical fibers 61.

In the example of FIG.12, it should be noted that the node 62A includes a multiple-wavelength optical amplifier 71 that amplifies optical signals of different wavelengths  $\lambda_1$ ,  $\lambda_2$ , ... simultaneously. By using the optical active device 40 or 50 of FIG.10 or 11 for the multiple-wavelength optical amplifier 71, it becomes possible to realize a polarization-free operation for the optical amplifier 71.

Further, it should be noted that the node 62B includes a wavelength switch for converting the wavelengths  $\lambda_1$ ,  $\lambda_2$ , ... of the incident optical signals to wavelengths of  $\lambda_i$ ,  $\lambda_k$ , ... in the output optical signals. By using the optical active device 40 or 50 explained previously for such a purpose, it becomes possible to realize polarization-free wavelength conversion.

Further, the present invention is not

limited to the embodiments described previously but
various variations and modifications may be made
without departing from the scope of the invention.